***SanDisk in Tefen is looking for Graduates***

**Position # 2032 – Failure Analysis Engineer**

**Job description:**
In this role the engineer will have to get a very high level description of a problem and to analyze it until he will have detailed conclusions of the root cause. The engineer will have to work with the measurement tools and to be creative.

**Requirements:**
1. BSc in Electronic or Electrical engineering with average grades of 80 minimum.
   - **Mandatory courses**: Thermodynamic, Random signals and noise, Semiconductors, VLSI and RF (advantage)
2. Ability to learn new products specifications
   a. Learn the existing test tools in SanDisk and be updated with the test capabilities in the market
3. Diagnose failures and suggest solutions
4. Self Motivation
5. Team work capability

**Position # 2031 - QA Test Engineer**

**Job Description:**
- Bug tracking
- Definition for internal testing tools
- Definition of test plan (Test Vs specs, Random tests, ATPS)

**Requirements:**
- BSC or equivalent: SW / HW / Electrical with average grades of 75 minimum.
- Graduate or up to 1 year of experience
- Knowledge in SW basics (any programming language)

*Please send CV's + Grades to sandisk_tefenCV@talent-sys.com*